

### US00D404720S

# United States Patent [19]

## Gayle

[45] Date of Patent: \*\*Jan. 26, 1999

Des. 404,720

[54]	HEAT SINK AND MOUNTING PLATE FOR INTEGRATED CIRCUITS			
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[**]	Term:	14 Years		
[21]	Appl. No.:	: 66,146		
[22]	Filed:	Feb. 6, 1997		
[51] [52] [58]	U.S. Cl	Cl		
[56]		References Cited		
	U.	S. PATENT DOCUMENTS		

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Primary Examiner—Brian N. Vinson

Patent Number:

[11]

[57]

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The ornamental design for a heat sink and mounting plate for integrated circuits, shown and described.

**CLAIM** 

#### **DESCRIPTION**

FIG. 1 is a perspective view of the heat sink and mounting plate for integrated circuits showing my new design;

FIG. 2 is a front elevational view thereof, the rear elevational view being identical in appearance;

FIG. 3 is a top plan view thereof, the bottom plan view being identical in appearance; and,

FIG. 4 is a side elevational view thereof, the opposite side view being identical in appearance.

### 1 Claim, 1 Drawing Sheet

